**WAFER SUPPORT RING**

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Field of Classification Search

USPC ........................................ D34/29

CPC ....................... H01L 21/67259; H01L 21/67742; H01L 21/67288; H02K 5/128

See application file for complete search history.

References Cited

U.S. PATENT DOCUMENTS

4,899,967 A * 2/1990 Johnson ....................... B65B 67/12 48/97
D457,283 S * 5/2002 Wayt ....................... D34/1
D591,924 S * 5/2009 Abe ....................... D34/35

CLAIM

The ornamental design for a wafer support ring, as shown and described.

DESCRIPTION

FIG. 1 is a top perspective view of a wafer support ring showing our new design;
FIG. 2 is a bottom perspective view thereof;
FIG. 3 is a top plan view thereof;
FIG. 4 is a bottom plan view thereof;
FIG. 5 is a front elevational view, with the rear being a mirror image thereof;
FIG. 6 is a cross sectional view taken at line 6-6 of FIG. 3; and,
FIG. 7 is a cross sectional view taken at line 7-7 of FIG. 3.

1 Claim, 6 Drawing Sheets